- Two Independent Controllers for Regulation of:
 - Fixed 2.5-V and an Adjustable Output
 - ±2% (Max) Regulation Across
 Temperature and Load (1 mA to 3 A)
- Adjustable Output Can Be Set Via an External Reference Pin, Allowing for the Creation of a Tracking Regulator
- Great Design Flexibility With Minimal External Components
- Applications: High-Current, Low-Dropout Regulators for:
 - DDR/RDRAM Memory Termination
 - Motherboards
 - Chipset I/O
 - GTLP Termination

NC - No internal connection

description/ordering information

The LFC789D25-ADJ is a dual linear FET controller that simplifies the design of dual power supplies. The device consists of two independent controllers, each of which drives an external MOSFET to implement a low-dropout regulator. One controller is programmed to regulate a fixed 2.5-V output, while the second controller can be programmed to regulate any desired output voltage via a reference input pin, allowing for the creation of a tracking regulator often needed for termination schemes. And because heating effects of the external FETs easily can be isolated from the controllers, the controllers can regulate the output voltages to a maximum tolerance of $\pm 2\%$ across temperature and load.

The LFC789D25-ADJ allows designers a great deal of flexibility in selecting external components and topology to implement their specific power-supply needs. With appropriate heat sinking, the designer can build a regulator with as much current capability as allowed by the external MOSFET and power supply. And, because the dropout of the regulator is simply the product of the R_{DS(on)} of the external power MOSFET and the load current, very low dropout can be achieved via proper selection of the power MOSFET.

Packaged in 8-pin SOIC and space-saving TSSOP, the LFC789D25-ADJ is characterized for operation from 0°C to 70°C.

ORDERING INFORMATION

TA	PACKAC	SE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	SOIC (D)	Tube of 75	LFC789D25-ADJCD	KADAC	
0°C to 70°C	3010 (b)	Reel of 2500	LFC789D25-ADJCDR	KADAC	
0 0 10 70 0	TCCOD (DIA)	Tube of 150		LFC789D25-ADJCPW	KADAC
	TSSOP (PW)	Reel of 2000	LFC789D25-ADJCPWR	NADAC	

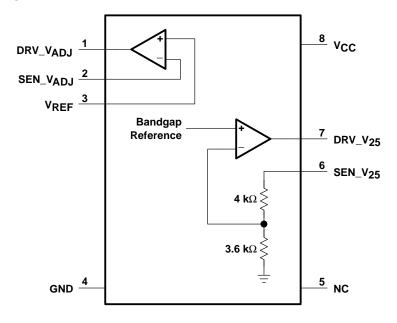
[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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functional block diagram



PIN DESCRIPTION

PIN	PIN NAME	PIN FUNCTION
1	DRV_V _{ADJ}	Output of adjustable controller. Drives gate(s) of FET(s) to output user-programmable voltage (VADJ)
2	SEN_V _{ADJ}	Sense input of adjustable controller. Senses changes in VADJ
3	VREF	Input pin used to program V _{ADJ} , allowing V _{ADJ} to track changes in V _{REF}
4	GND	Ground
5	NC	No connection
6	SEN_V ₂₅	Sense Input of 2.5-V controller. Senses changes in 2.5-V supply
7	DRV_V ₂₅	Output of 2.5-V controller. Drives gate(s) of FET(s) to output fixed 2.5 V
8	Vcc	Power supply for device

typical application circuit

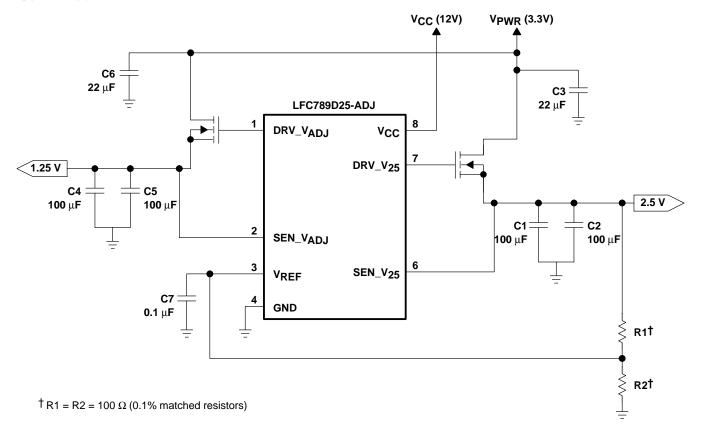


Figure 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	18 V
Input voltage range, V _{REF} , SEN_V _{ADJ} , SEN_V ₂₅	
Package thermal impedance, θ _{JA} (see Notes 2 and 3): D package	97°C/W
PW package	149°C/W
Operating virtual junction temperature, T _J	150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.
 - 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
Vcc	Supply voltage	9	16	V
TA	Operating free-air temperature	0	70	°C



LFC789D25-ADJ DUAL LINEAR FET CONTROLLER

SLLS565 - MARCH 2003

electrical characteristics, $V_{\mbox{CC}}$ = 12 V $\pm 5\%,\,T_{\mbox{A}}$ = 25°C (unless otherwise noted)

	PARAM	ETER	TEST CONDITIONS	TA	MIN	TYP	MAX	UNIT	
	ı	VADJ sense-pin current				-20		nA	
Sense	I _{SEN_VADJ}	VADJ sense-pin current		Full range			-500	ПА	
Jense	1	V ₂₅ sense-pin current	V ₂₅ = 2.5 V			125		μΑ	
	SEN_V ₂₅	v25 sense-pin current	V25 = 2.3 V	Full range			500	μΛ	
	.,	D:			V _C C -1.5			.,	
Driver	V _{DRV}	Driver output voltage	I _{DRV} = 0	Full range	V _{CC} -3			V	
	1	Driver output current	V _{DRV} = 4 V,			10		mA	
	IDRV	Driver output current	VSEN = 0.8 VOUT (nom)	Full range	5				
Reference		Pin current, V _{REF}				-20	-250	nA	
Reference	I _{VREF}	Till culterit, VREF		Full range			-500	IIA	
		V ₂₅ output voltage	$I_{OUT} = 1 \text{ mA to } 3 \text{ A},$			2.5			
Output regul	ation	regulation	$V_{PWR} = 3.3 V \pm 10\%$	Full range	2.45	2.5	2.55		
Output regulation (see Figure 1)		Van Loutout voltage	$I_{OUT} = 1 \text{ mA to } 2 \text{ A},$			V_{REF}		V	
		V _{ADJ} output voltage regulation	$V_{PWR} = 3.3 \text{ V} \pm 10\%,$ $V_{REF} = V_{25}/2$	Full range	0.98× VREF	V _{REF}	1.02× V _{REF}		
Supply	laa	Supply current				2		mA	
Supply	Icc	Supply Culterit		Full range			2.5	IIIA	

APPLICATION INFORMATION

FUNCTIONAL DESCRIPTION

A linear voltage regulator can be broken down into four essential building blocks: a pass transistor, a voltage reference, a feedback network, and a control circuit to drive the pass element, based on the comparison between the output voltage (as sampled by the feedback network) and the voltage reference. With the exception of the pass transistor, the LFC789D25-ADJ provides the other three building blocks needed. Thus, with minimal external components and low overall solution cost, a designer can create two independent, tightly regulated output voltages capable of delivering high currents in excess of 3 A (as limited by the external pass transistor). One output is fixed at 2.5 V. The other output can be adjusted to any desired voltage via an externally applied signal to the V_{REF} pin. Because the output of the regulator always tracks any changes to this V_{REF} pin, it is relatively easy to implement a tracking regulator. See the *typical application circuit* (Figure 1).

internal reference

The fixed 2.5-V output controller uses an internal temperature-compensated bandgap reference centered at 1.2 V. Its tolerance is designed to be <±2% over the specified temperature range, which, when coupled with the low offset of the driver circuit, allows the 2.5-V output to have a tolerance of 2% over the specified temperature range and full load.

external reference pin (V_{REF})

For the adjustable output controller, the V_{REF} pin allows great flexibility for the designer. Taking a simple resistor divider tied to an external voltage source and connecting the divider to the V_{REF} pin allows the controller to regulate an output voltage that is some fraction of the external voltage source. And, because any changes in the external voltage source are sensed by the voltage divider, the regulated output tracks those changes.

If a tracking regulator is not desired, a fixed voltage can be achieved by applying a constant voltage to the V_{REF} pin. This signal can be provided by a simple device such as the economical TL431 adjustable shunt regulator.

The V_{REF} pin typically *sources* a current of 20 nA and, as such, has a minimal loading effect on the resistor divider or the shunt regulator. The accuracy of the adjustable output depends on the accuracy of the signal applied to the V_{REF} pin. Using high-precision resistors or a TL431A (1% output tolerance) helps achieve good accuracy.

feedback network (SENSE pins)

The 2.5-V controller senses the output voltage via the SEN_{25} pin. This pin is tied to an internal resistor divider that essentially halves the sensed output voltage and feeds it back to the controller for comparison to the internal bandgap reference.

For the adjustable output controller, the SEN_ V_{ADJ} pin provides direct feedback of the output voltage to the controller for comparison to the externally applied V_{REF} signal.

controller/driver

Both drivers are essentially error amplifiers that can output a worst-case minimum of 9 V (10.5 V at 25° C) when the LFC789D25-ADJ is powered by 12 V. This allows the controllers to regulate a large range of output voltages, as limited by the threshold voltages of the external NMOS. Both drivers sample the output voltage via a SEN pin. For the adjustable version, this SEN pin typically *sources* a current of 20 nA and, thus, has minimal loading on the output voltage. For the 2.5-V version, this SEN pin *sinks* a current about 125 μ A (including the currents through the internal resistor divider); this results in minimal loading on the output voltage.

Although not tested, both of these controllers are designed with very low offset (typically less than 4 mV), resulting in very accurate control of the drive signals.



APPLICATION INFORMATION

MOSFET SELECTION: BENEFITS OF NMOS PASS ELEMENTS REVISITED

A great benefit of having an external pass element is that the control circuitry can be powered by a separate supply (V_{CC}), other than the one used as the input to the pass element (V_{PWR}). This feature allows the use of an NMOS pass element, which requires a positive $V_{GS} > V_T$ for operation. With a separate V_{CC} pin to the controller, the voltage at the gate of the NMOS readily can exceed the voltage at the drain; thus, V_{GS} easily can exceed $V_{DS} + V_T$, allowing the NMOS to operate in the triode region ($V_{DS} \ge V_{GS} - V_T$). In the triode region, V_{DS} can be very small, thus achieving very low dropout.

The external NMOS selected for the pass transistor has significant impact on the overall characteristics of the regulator, as discussed in the following paragraphs.

Maximum output current

A benefit of an external pass element is that the designer can size the NMOS to comfortably sustain the maximum I_{OUT} expected. This allows great flexibility, along with cost and space savings, because each regulator has its pass element tailored to its individual needs. In addition, using a NMOS pass element allows for smaller size (and subsequently, lower cost) than a PMOS element for the same current-carrying ability.

Dropout

Choosing an NMOS with very low $R_{DS(on)}$ characteristics provides the regulator with very low dropout because dropout will be $\sim I_{OUT} \times R_{DS(on)}$. This lower dropout also results in better efficiency and lower heat dissipation in the pass element for a given I_{OUT} .

Maximum programmable output voltage and nmos threshold voltage, V_T

The maximum output voltage that can be regulated by the programmable regulator depends on the device's power supply (V_{CC}) and threshold voltage (V_T) of the NMOS. With the drive voltage tied to the gate and V_{OUT} connected to the source of the NMOS, a minimum $V_{GS} = V_T$ must be maintained in order to maintain the n-channel inversion layer. The maximum V_{OUT} is calculated as follows:

$$V_{OUT} = V_S = V_G - V_T$$

With V_{CC} = 12 V and a corresponding worst-case gate drive voltage of 9 V, the highest achievable V_{OUT} = 9 V - V_T.

Stability

A quality of the old npn regulators was their inherent stability for almost any type of load conditions and output capacitors. An NMOS regulator has the same benefit. Thus, capacitor selection and equivalent-series-resistance (ESR) values are not needed for stability, but still should be chosen properly for best transient response (see below).

capacitor selection

C_{out}: Although a minimum capacitance is not needed for stability with an NMOS pass device, higher capacitance values improve transient response. In addition, low-ESR capacitors also help transient response. Tantalum or aluminum electrolytics can be used for bulk capacitances, while ceramic bypass capacitors can be used to decouple high-frequency transients due to their low ESL (equivalent series inductance).

 C_{in} : Input capacitors placed at the drain of the NMOS pass transistor (V_{PWR}) help improve the overall transient response by suppressing surges in V_{PWR} during fast load changes. Low-ESR tantalum or aluminum electrolytic capacitors can be used; higher capacitance values improve transient response. A 0.1- μ F ceramic capacitor can be placed at the V_{CC} pin of the LFC789D25-ADJ to provide bypassing.



APPLICATION INFORMATION

layout

Another benefit of a separate controller and pass element is that the heat dissipated in the external NMOS can be well isolated from the controller, which has very low power dissipation. Both of these factors allow the bandgap reference and control circuitry to operate over a more stable temperature range, resulting in very good accuracy over full-load conditions. The LFC789D25-ADJ should be placed as close as possible to the external pass element because short PCB traces allow minimal EMI coupling to both the drive and sense lines.

For best accuracy, connect the SEN pins as close to the load as possible, not to the source of the NMOS. Also, place the SEN trace in the same direction and plane as the power trace that connects the source of the NMOS to the load. Also, it is good practice to keep the load current return path as far as possible from the SEN trace.

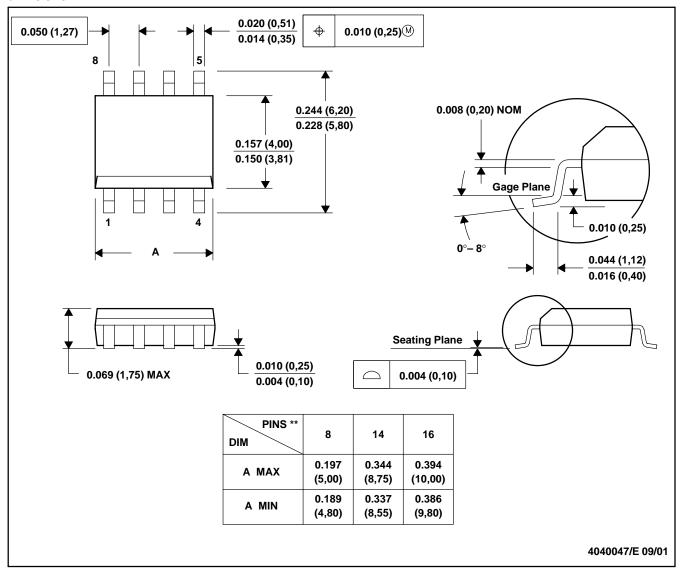
Place the 0.1- μ F bypass capacitor as close as possible to the V_{CC} pin and connect it directly to the ground plane. The GND pin of the LFC789D25-ADJ should be connected to the ground plane.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

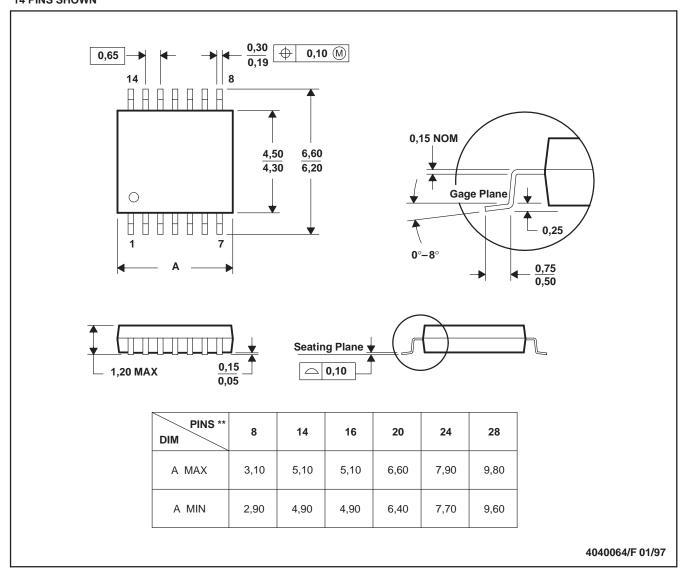
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Product Folder: LFC789D25-ADJ, Dual Linear FET Controller

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LFC789D25-ADJ. Dual Linear FET Controller

DEVICE STATUS: ACTIVE

PARAMETER NAME	LFC789D25-ADJ
Iq (typ) (mA)	2
Vin (max) (V)	18
Tolerance (%)	2
Shutdown	No
VO (min) (V)	2.5, Adjustable
Idrive (max) (mA)	10

FEATURES Back to Top

- Two Independent Controllers for Regulation of:
 - Fixed 2.5-V and an Adjustable Output
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DESCRIPTION ▲Back to Top

The LFC789D25-ADJ is a dual linear FET controller that simplifies the design of dual power supplies. The device consists of two independent controllers, each of which drives an external MOSFET to implement a low-dropout regulator. One controller is programmed to regulate a fixed 2.5-V output, while the second controller can be programmed to regulate any desired output voltage via a reference input pin, allowing for the creation of a tracking regulator often needed for termination schemes. And because heating effects of the external FETs easily can be isolated from the controllers, the controllers can regulate the output voltages to a maximum tolerance of $\pm 2\%$ across temperature and load.

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TECHNICAL DOCUMENTS ▲Back to Top

To view the following documents, Acrobat Reader 4.0 is required.

To download a document to your hard drive, right-click on the link and choose 'Save'.

DATASHEET ▲Back to Top

Full datasheet in Acrobat PDF: lfc789d25-adj.pdf (145 KB) (Updated: 03/04/2003)

APPLICATION NOTES ▲Back to Top

Product Folder: LFC789D25-ADJ, Dual Linear FET Controller

- Analog Applications Journal (Rev. A) (SLYT010A Updated: 03/17/2000)
- Digital Designer's Guide to Linear Voltage Regulators & Thermal Mgmt (SLVA118 Updated: 07/23/2002)
- PowerFLEX (TM) -- Surface-Mount Alternative for Through-Hole Power Packages (SZZA015 Updated: 04/08/1999)
- Supply Voltage Drop On Fast Current Demand (SLVA076 Updated: 09/03/1999)

MORE LITERATURE ▲Back to Top

- Enhanced Plastic Portfolio Brochure (SGZB004, 387 KB Updated: 08/19/2002)
- Portable/System Power Sales Tool Brochure 3Q 2002 (SLPB006, 153 KB Updated: 08/23/2002)
- QML Class V Space Products Military Brief (Rev. A) (SGZN001A, 257 KB Updated: 10/07/2002)

SAMPLES	<u>■Back to Top</u>								
ORDERABLE DEVICE	PACKAGE INDUSTRY (TI)	<u>PINS</u>	TEMP (°C)	<u>STATUS</u>	PRODUCT CONTENT	<u>SAMPLES</u>			
LFC789D25-ADJCDR	SOIC (D)	8	0 TO 70	ACTIVE	<u>View Product Content</u>	<u>Request Samples</u>			
LFC789D25-ADJCPWR	TSSOP (PW)	8	0 TO 70	ACTIVE	<u>View Product Content</u>	<u>Request Samples</u>			

PRICING/AV	PRICING/AVAILABILITY/PKG ▲Back to Top											
DEVICE INFOR Updated Daily	DEVICE INFORMATION Updated Daily					TI INVENTORY STATUS As Of 08:00 AM GMT, 17 Apr 2003			REPORTED DISTRIBUTOR INVENTORY As Of 08:00 AM GMT, 17 Apr 2003			
ORDERABLE DEVICE	<u>STATUS</u>	PACKAGE TYPE PINS	TEMP (°C)	PRODUCT CONTENT	BUDGETARY PRICING QTY \$US	<u>STD</u> <u>PACK</u> <u>QTY</u>	IN STOCK	<u>IN PROGRESS</u> QTY DATE	LEAD TIME	DISTRIBUTOR COMPANY REGION	IN STOCK	PURCHASE
LFC789D25- ADJCD	ACTIVE	SOIC 8	0 TO 70	<u>View Contents</u>	1KU 0.33	75	<u>0</u> *	>10k 16 May	5 WKS	None Reported View Distributors		
LFC789D25- ADJCDR	ACTIVE	SOIC 8	0 TO 70	<u>View Contents</u>	1KU 0.33	2500	<u>2500</u> *	>10k 12 May	5 WKS	None Reported <u>View Distributors</u>		
LFC789D25- ADJCPW	ACTIVE	<u>TSSOP</u> 8	0 TO 70	<u>View Contents</u>	1KU 0.33	150	<u>0</u> *	>10k 16 May	6 WKS	None Reported <u>View Distributors</u>		
LFC789D25- ADJCPWR	ACTIVE	<u>TSSOP</u> 8	0 TO 70	View Contents	1KU 0.33	2000	<u>0</u> *	1158 21 Apr	6 WKS	None Reported <u>View Distributors</u>		
								>10k 15 May				

Table Data Updated on: 4/17/2003